



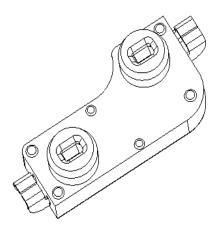


## **Document Number:**

KH-PS2110-08

# 产品规格书

# Product Specification



<u>P/N:</u>		Tit	le:		
	CPG1511	01S11-2	1511	Connector	
Rev.	ECN	Release and Revision Description:	Prepared By /Date:	Checked By/Date:	Approved By/Date:
A		New releasing 初版发行	胡海鑫/2021.10.13	胡前程/2021.10.13	郑建军/2021.10.13



日忠



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#### 1. Scope/范围:

This Product Specification covers the requirement of Mechanical keyboard Connector switch on product performance, test methods and quality assurance provisions.

本规格书内容涵盖机械键盘连接器产品的要求,包括性能指标、测试方法及质量保证方面等。

#### 2. Product Application/产品应用:

Mainly applied on computer keyboards, cash registers equipment and Man-Machine interface.

主要适用于电脑, 收银机, 工业设备和人机界面

#### 3. Technology Parameters/技术参数

Ambient Humidity 工作湿度: 45~95% R.H.;

Operating Temperature Range 使用温度范围: -10  $^{\circ}$   $^{\circ}$  +60  $^{\circ}$  ; Storage Temperature Range 保存温度范围: -20  $^{\circ}$   $^{\circ}$ 

**Normal Condition:** 

Ambient temperature 环境温度:

Relative humidity 相对湿度: 85%±5% R.H.;

Air pressure 气压: 86~101KPa; Contact Resistance 接触阻抗: 100 m Ω Max;

Solder Ability 可焊性: 100 m<sup>2</sup> wax; 260±5℃,3±0.5s;

Withstand Soldering Temperature 耐焊接热: 260±5℃,5±0.5s;

#### 4. Ratings/额定性能要求

Rating Voltare 额定电压:

Rating Current 额定电流

InsulationResistance 绝缘电阻:

Withstand Voltage 耐电压:

Mechanical Life 机械寿命:

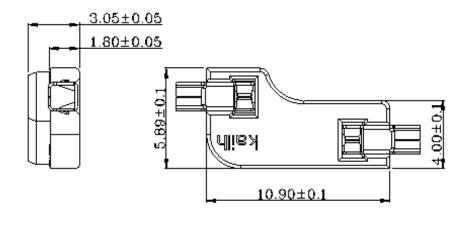
12V AC/DC max; 2V DC min 10mA AC/DC max; 10uA DC min

 $\geq$ 100M $\Omega$ /DC 500V; AC 100V 1 Minute;

15000Cycles.

**20**±**2**℃

#### 5. Profile Dimensions /外形尺寸





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#### 6. Electrical Performance/电气性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求		
6.1	Contact Resistance 接触电阻	Static load: (Operation force)x2, which is applied on the center of Switch stem. 静态负载: 动作力的 2 倍,施加在手柄中心.  Measurement tool: Contact resistance Meter. 测量工具: 微电流接触电阻计(1KHz, 20mV,5~50mA)			
6.2	Insulation Resistance 绝缘电阻	Apply a Voltage of DC 500 V for 1 minute, according to the below method. (1) Between terminals. (2) Between terminal and Body. 输入 500V DC 电压 1 分钟,按如下接触方法测试: (1) 端子与端子之间. (2) 端子与外壳之间.	100MΩ Min 100 兆欧以上		
6.3	withstanding breakd		No evidence of breakdown 无瞬断、击穿等破坏.		

### 7. Mechanical Performance/机械性能

I I	ltem 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求	
	7.1	Mating force 插入力	At 16in/minute.actuation speed	Mating force 插入力 3KG max	



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	7.2	Unmating force 拔出力	At 16in/minute.actuation speed	Unmating force 拔出力 200gf min
	7.3	Shock 机械冲击	Measured by according to the below condition: (1) Acceleration: 80g 加速度 (2) Cycles of test:3 cycles each in 6 directions, for a total of 18 cycles. 试验次数:每个方向 3 次,6 个方向共 18 次.	Appearance: No abnormality. 外观无异常
	7.4 Life Test 寿命测试  (1) No load 无负载  (2) Mating force: Maximum value of operation force. 插入力: 操作力规格值的上限.  (3) Cycles: 15000 Min 操作次数: 15000 次以上		Contact resistance: 1000 m Ω Max 接触电阻: 1000 毫欧以下 Bouncing: 10ms Max	

### 8. Environmental Performance/环境性能

Item 项目	Description 项目描述	Test Condition 测试条件	Requirement 规格要求	
8.1	Cold test 耐寒性	(1) Temperature: - 20±2℃ 温度: - 20±2℃ (2) Duration of test: 48h 持续时间: 48 小时 (3) Take off a drop water 去掉水珠 (4) Standard conditions after test: 1h 试验后的放置条件: 1 小时	Contact resistance: 200m Ω Max 接触电阻 200m Ω以下	



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8.2	Heat test 耐热性	温度: 7 (2) Duratio 持续时间 (3) Take o (4) Standa	rature: 70년 0±2℃ on of test: 48h 闰:48 小时 ff a drop wate ard conditions 均放置条件:		Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2	
8.3	Temperature cycle 温度循环	试验周 (2) Standa	ycles: 5 cycles 期: 5 个周期 yrd condition a 的放置条件: Temperature 温度 20±5℃ -20±5℃ 70±5℃	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2		
8.4	Soldering heat test 耐焊接热	Soldering area: T/2 of PWB thickness. (PWB: T=1.6mm) 焊接面积: 印刷基板的 1/2 厚度处 Soldering temperature: 260±5℃ Soldering time: 5±0.5s 焊接温度: 260±5℃ 焊接时间: 5±0.5 秒				Appearance: No abnormality. 外观无异常
8.5	Solderability 可焊性	<ol> <li>Hand soldering 手工焊接: Please practice according to below condition:         <ul> <li>(1) Soldering Temperature: 350±5℃ 焊接温度: 350±5℃</li> <li>(2) Continual soldering time: 3±0.5s 连续焊接时间: 3±0.5 秒</li> <li>(3) Capacity of soldering iron: ≤20w 电烙铁功率: 20 瓦以下</li> </ul> </li> <li>Automatic Reflow soldering 自动回流焊接: For the product of SMT, according to below condition:</li> </ol>			At least 90% of surface area of immersed portion shall be covered by solder. 侵焊面积大于 95%以上.	



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8.6	Humidity test 耐湿性	<ul> <li>(1) Temperature: 60±2℃ 温度: 60±2℃</li> <li>(2) relative humidity: 90~95% R.H. 相对湿度:90~95% R.H.</li> <li>(3) Duration of test: 48h 持续时间: 48 小时</li> <li>(4) Take off a drop water 去掉水珠</li> <li>(5) Standard conditions after test: 1h 试验后的放置条件: 1 小时</li> </ul>	Contact resistance: 200m Ω Max Shall meet: No. 6.2 接触电阻 200m Ω以下 满足: No. 6.2
8.7	Salt Spray 盐雾测试	Apply the following environment to test: 根据下列条件进行测试: (1) Temperature: 35±5℃ 温度: 35±5℃; (2) Salt water density: 5±1% 盐水浓度: 5±1%; (3) Duration: 12 hours 持续时间: 12 小时; (4) After test, the salt deposit shall be removed by running water. 实验后将盐沉积物用水冲掉	Appearance: No corrosion spot, no crack, no base plate naked. 外观: 无腐蚀点, 无裂纹, 无裸露基材.  Contact Resistance: 200 m Ω Max 接触电阻: 200 毫欧以下



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8.8	Withstand K₂S 硫化测试	Apply the following env 根据下列条件进行测试 (1) Temperature: 35±5 (2) K <sub>2</sub> S Density: 2%; 硫化钾浓度: 2% (3) Duration: 2 minute. 持续时间: 2 分钟		!	Appearan No corros crack, no naked. 外观: 无原 无裸露基 Contact R 1000 m Ω 接触电阻: 下	ion spot, base plat 弱蚀点,无 材. desistance Max	e 裂纹, s:



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#### 9. Recommended PCB Layout 推荐的 PCB 安装焊盘规格

(Top View)

(Single face board T=1.6mm)



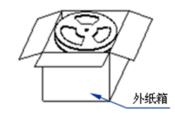
#### 10. Packaging 包装

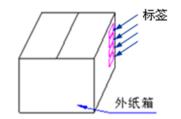
Packaging type: 13Tray, 26000Pcs/Carton.

包装方式:13/盘, 26000Pcs/箱.



卷盘





11.1 Soldering condition 回流焊条件

11.1 Soldering condition 回流净余件					
ITEM		CONDITION			
项目		条件			
	Heating zone	Speed<2°C/S, Preheating time15 S Max,temperture150°C			
	升温区	速度<2°C/S,预热时间 15 S 最多,温度 150°C			
Drobooting zono	Heatpreservati	Speed 1.20.2 5°C/S. Probacting time 120 S. May temporture 190°C			
Preheating zone	on area	Speed1. 2~3. 5°C/S,Preheating time120 S Max,temperture180°C			
预热区 	保温区	速度 1. 2~3. 5℃/S,预热时间 120S 最多,温度 180℃			
	Fast heating zone	Speed3. 5~4. 5°C/S, Preheating time140 S Max,temperture230°C			
	快速升温区	速度 3.5~4.5℃/S,预热时间 140 S 最多,温度 230℃			
Weld area		Welding time 40 S Max , welding temperature peak value, 3 sec Max.			
焊接区		焊接时间 40 S 最多, 焊接温度峰值 260℃ 最大,3 S 最多			
Area of flux		1/2 Max of PWB Thickness			
助焊剂面积		印刷基板厚度的 1/2 以内			
Temperature of s	older	260±5℃			
焊锡温度		260±5℃			
Number of solder	ing	2time Max (But should down heat of the first soldering)			
焊接次数		2次以内			
Printed wiring box	ard	Single side copper-clad laminates			
印刷基板		单面铜箔			

(1) After reflow, be careful not to clean switches with solvent

回流焊后,注意不要用溶剂清洗.

(2) Under the condition of using soldering iron, soldering temperature shall be 350°C max within 3 sec. 在使用铬铁的情况下,焊锡温度应在350℃以下,焊接时间3秒以内.



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#### 11.2 Notes 注意点

(1) Please be cautious not to give excessive static load connector. 注意不要施加超负荷的压力或晃动连接器.

- (2) Connector be careful not to stack up P. W. B. after switches were soldered. 连接器焊接以后,印刷基板注意不要叠放.
- (3) Preservation under high temperature and high humidity or corrosive gas should be avoided Especially. When you need to preserve for a long period, do not open the carton. 保管时尤其应注意避开高湿高温和有腐蚀性气体的环境.如需长时间保存,请不要打开包装箱.
- (4) The standard storage period is 3 months, with maximum up to 6months, preferably to be used as soon as possible. After opening the package, you should put the remaining switches in a plastic bag to prevent from damp and corrosive gas.
  - 保存标准为 3 个月,限度为 6 个月以内,请尽早使用. 打开包装后,有剩余品时,应将剩余部分以胶袋包装好以同外界隔离,请进行合适的防湿,防腐蚀气体等处理后进行保管.
- (5) This Product Specification is considered as the technical agreement on product between the receiving customer and Kailh. Any information on Product Catalogue which is in conflict with or different from the corresponding information of this document is considered as invalid. 该规格书为客户与凯华公司产品在技术方面的共识,其他相关数据上与该规格书不一致的内容都是无效的.
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